



# MS IF REPLY UNDER 37 C.F.R. § 1.312 EXPEDITED PROCEDURE **EXAMINING GROUP 1712**

PATENT

0171-0759P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:

Shoichi OSADA et al.

Conf.:

Appl. No.:

09/883,276 V

Group:

Filed:

June 19, 2001

Examiner: Marc ZIMMER

For:

SEMICONDUCTOR ENCAPSULATING EPOXY RESIN

COMPOSITION AND SEMICONDUCTOR DEVICE

### LARGE ENTITY TRANSMITTAL FORM

HANDCARRY TO:

March 19, 2004

U.S. Patent and Trademark Office 2011 South Clark Place Customer Window Crystal Plaza Two, Lobby, Room 1B03 Arlington, VA 22202

Sir:

Transmitted herewith is an amendment in the above-identified application.

The enclosed document is being transmitted via the Certificate of Mailing provisions of 37 C.F.R. § 1.8.

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The fee has been calculated as shown below:

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TOTAL	13	-	20	=	0	\$ 18	\$0.00
INDEPENDENT	4	-	4	11 .	0	\$ 86	\$0.00
FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM						\$290	\$0.00
						TOTAL	\$0.00

		(s) extension of time pursuant to 5(a). \$0.00 for the extension of				
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over requ	current, and future replies, rpayment to Deposit Account No	ner is hereby authorized in this, to charge payment or credit any o. 02-2448 for any additional fees 16 or under 37 C.F.R. § 1.17; Eees.				
	Resp	pectfully submitted,				
·	BIRC	CH, STEWART, KOLASCH & BIRCH, LLP				
	By	ndrew D. Meikle, #32,868				
•	RF P.O. /RG/csm Fall	Box 747 s Church, VA 22040-0747 s) 205-8000				
Atta	achment(s)					

(Rev. 09/30/03)



# MS IF REPLY UNDER 37 C.F.R. § 1.312 EXPEDITED PROCEDURE EXAMINING GROUP 1712 PATENT 0171-0759P

## IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:

Shoichi OSADA et al.

Conf.:

9440

Appl. No.:

09/883,276

Group:

1712

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June 19, 2001

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Marc ZIMMER

For:

SEMICONDUCTOR ENCAPSULATING EPOXY RESIN

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## **AMENDMENT UNDER 37 CFR 1.312**

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March 19, 2004

U.S. Patent and Trademark Office 2011 South Clark Place Customer Window Crystal Plaza Two, Lobby, Room 1B03 Arlington, VA 22202

Sir:

The following amendments and Remarks are respectfully submitted in connection with the above-identified application.

This Paper includes:

Amended Claim Set; and

Remarks.